ASSOCIATION CONNE	Material Compo © Copyright 2005. IP international and Pan-	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					rials and M	ials and Mfg Information			
Supplier Info	rmation														
Company name* Company unic				ique ID			Unique ID Authority				Respon	Response Date*			
nsemi											2024-04	2024-04-19			
Contact Name		Title - Contact			P	Phone - Contact*				Email -	Email - Contact*				
Product-Env-Ste	ewards		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
uthorized Repr	esentative*	Title - Representative			P	Phone - Representative*				Email -	Email - Representative*				
Product-Env-Ste	ewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com					
Reque	Requester Item Number M		Mfr Item Number Mfr Item Name				Effective Date	Version	1 .	Manufacturing Site		Weight*	UOM	Unit Type	
		FUSB3307D45A0AF 45W USB Type-C		C PD Source Cont	troller	2024-04-19 PH1		PH1		125.06	mg	Each			
Ianufacturi r	ng Proccess Informat	ion													
Terminal Plating / Grid Array Material T			Ferminal Base Alloy J-STD-020 MSL		Rating	Peak Process Body Temperature Max Time at Peal			k Temperature Number of Reflow Cycles						
Matte Tin (Sn) - annealed		(CU Alloy 3		3		260		С	30	secor	nds 3			
omments															
TTENTION: M	ISL 3 Rated item requires	Bake and D	ry Pack (after	electrical test)											
or more inform	ation regarding material o	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correction to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale a											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.653	mg	Supplier	Silicon (Si)	7440-21-3		3.653	mg
Die Attach	4.44	mg		Epoxy resin	proprietary data		1.0212	mg
			Supplier	Silver (Ag)	7440-22-4		3.4188	mg
Lead Frame	69.62		Supplier	Silver (Ag)	7440-22-4		0.1532	mg
			Supplier	Zinc (Zn)	7440-66-6		1.1975	mg
			Supplier	Silicon (Si)	7440-21-3		0.3829	mg
			Supplier	Iron (Fe)	7439-89-6		1.7544	mg
			Supplier	Copper (Cu)	7440-50-8		66.132	mg
Mold Compound-Black	43.43		Supplier	Carbon Black (C)	1333-86-4		0.2172	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		38.0013	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		2.6058	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.6058	mg
Plating	3.27	mg	Supplier	Tin (Sn)	7440-31-5		3.27	mg
Wire Bond - Au	0.647	mg	Supplier	Gold (Au)	7440-57-5		0.647	mg